### **IEC/PAS 62336**

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#### PUBLICLY AVAILABLE SPECIFICATION





Reference number IEC/PAS 62336



# JEDEC STANDARD

Accelerated Moisture Resistance - Unbiased HAST

Prev

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**DECEMBER 2000** 

JEDEC SOLID STATE TECHNOLOGY ASSOCIATION







#### INTERNATIONAL ELECTROTECHNICAL COMMISSION

## ACCELERATED MOISTURE RESISTANCE – UNBIASED HAST

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47/1635/PAS	$\langle \langle \rangle \rangle$	\ /	47	/1645	₹VD	

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